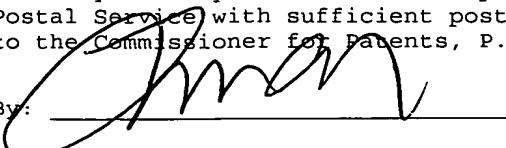
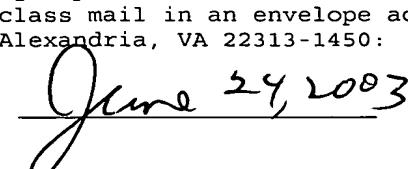




WMP-EUP-008

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7/17/03  
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Gottfried Ferber et al.

Applic. No. : 10/056,770

Filed : January 24, 2002

Title : Semiconductor Module and Method for  
Fabricating the Semiconductor Module

Examiner : Long K. Tran

Group Art Unit : 2818

TECHNOLOGY CENTER 2800  
JUN 30 2003

RECEIVED

AMENDMENT

Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir :

Responsive to the Office action dated March 26, 2003 kindly  
amend the above-identified application as follows: